



(3583)

2022/08/30

Safe Harbor Statement

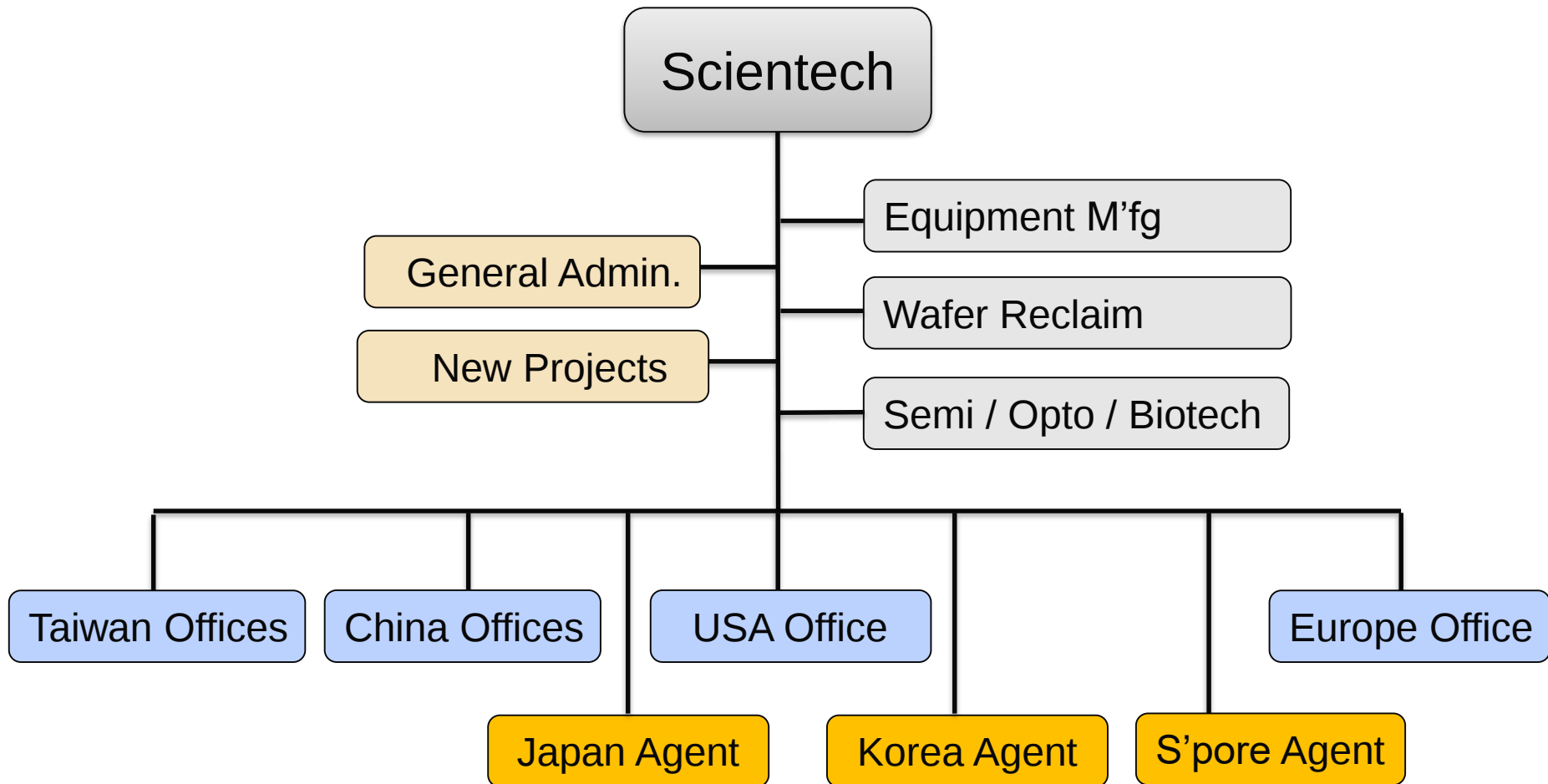
- This Presentation contains certain forward-looking statements that are based on current expectations and are subject to known and unknown risks and uncertainties that could cause actual results to differ materially from those expressed or implied by such statements.
- Except as required by law, we undertake no obligation to update any forward –looking statements, whether as a result of new information, future events or otherwise.

Sciencetech Corp (3583: TT)



Establishment	1979/10/17
Chairman & CEO	H.L. Hsieh
CEO	M.T. Hsu
Capital	NT\$ 811 Million
Revenue(2021)	NT\$ 4,684 Million (consolidated)
No. Employees	740 (Consolidated)
Location	1.Taiwan : Taipei, Hukou , Hsinchu, Tainan, Kaohsiung 2.Subsidiary Company : China(17 cities including Shanghai) , HK,USA , Europe(Austria) 3.Business Support : Japan,Singapore,South Korea
Products	Equipment Manufacturing 、 Wafer Reclaim 、 Trading(Agent/Distributor)

Organization



Business
Overview

Products

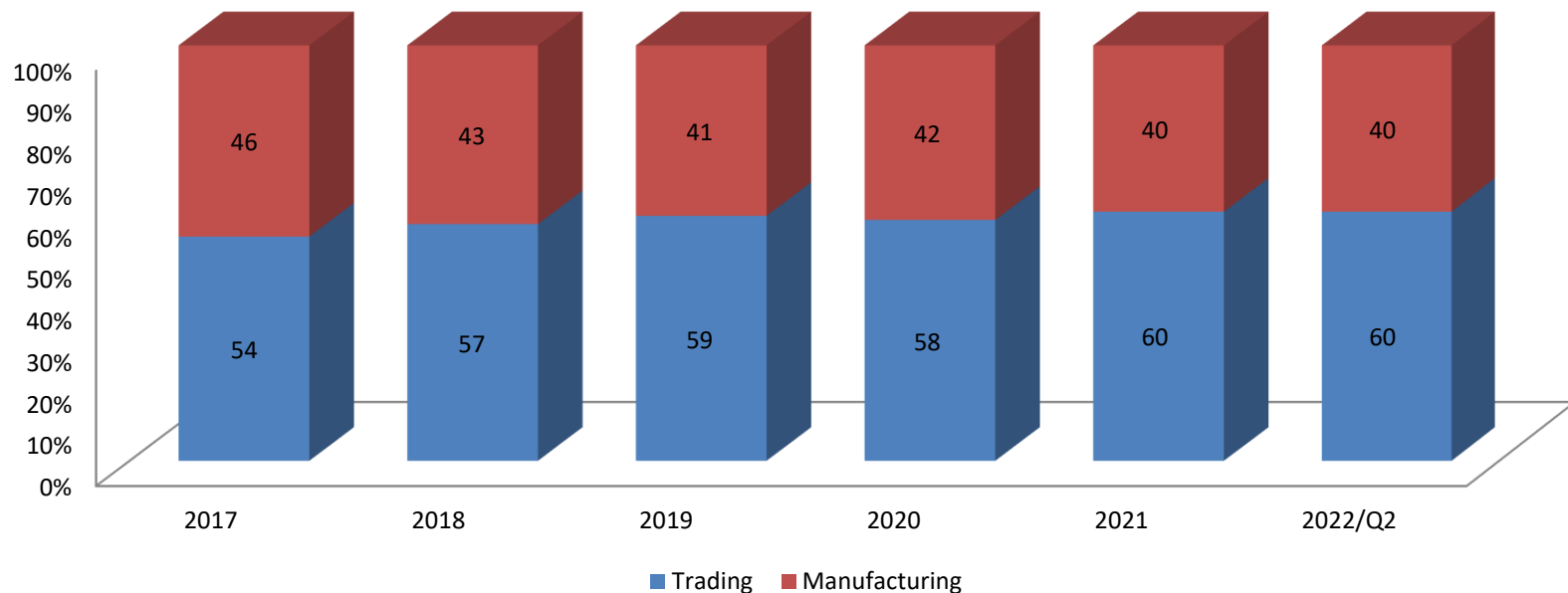
Corporate
Governance

Future
Prospect

Units : NT \$ M	2017	2018	2019	2020	2021	2022/H1
Revenues	<u>3,539</u>	<u>3,988</u>	<u>3,949</u>	<u>3,580</u>	<u>4,684</u>	<u>2,637</u>
Gross Profit	<u>1,251</u>	<u>1,448</u>	<u>1,384</u>	<u>1,456</u>	<u>1,667</u>	<u>972</u>
Operating Expenses	829	935	997	991	1,112	670
Operating Income	423	514	387	465	555	302
Other Income and Expenses	(8)	26	16	(76)	(31)	29
Income Before Tax	415	540	403	389	524	331
Net Income	328	418	323	305	420	273
EPS	<u>4.05</u>	<u>5.16</u>	<u>4.02</u>	<u>3.80</u>	<u>5.23</u>	<u>3.40</u>
Gross Margin	35%	36%	35%	41%	36%	37%
Operating Margin	12%	13%	10%	13%	12%	11%
Income Before Tax margin	12%	14%	10%	11%	11%	13%

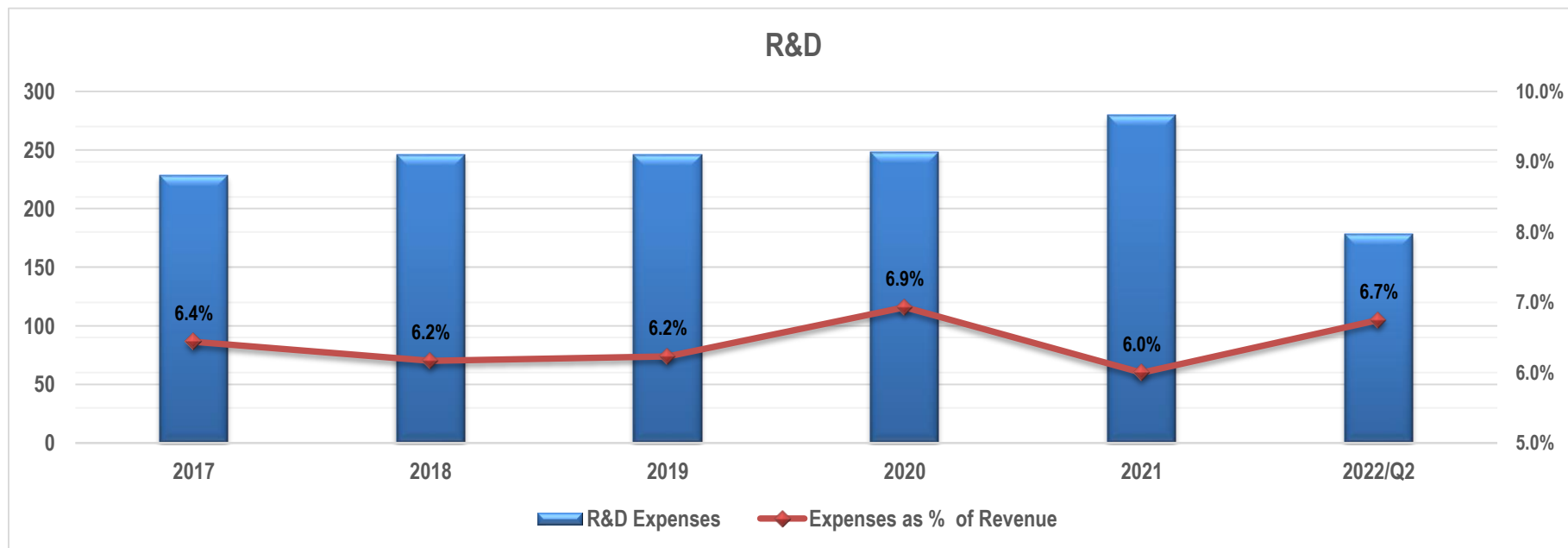
Units : NT \$ M	1Q22	2Q22	1Q21	2Q21	1H22	1H21	1H22over1H21
Revenues	1,254	1,383	956	1,002	2,637	1,958	35%
Gross Profit	461	511	266	397	972	663	47%
Operating Expenses	332	338	253	219	670	472	42%
Operating Income	129	173	13	178	302	191	58%
Other Income and Expenses	26	3	24	(8)	29	16	79%
Income Before Tax	155	176	37	170	331	207	60%
Net Income	121	152	20	147	273	167	64%
EPS	1.51	1.89	0.25	1.84	3.40	2.09	63%
Gross Margin	36.8%	36.9%	27.8%	39.6%	36.9%	33.9%	+3.0ppt
Operating Margin	10.3%	12.5%	1.4%	17.8%	11.4%	9.8%	+1.6ppt
Income Before Tax margin	12.4%	12.7%	3.9%	17.0%	12.5%	10.6%	+1.9ppt

Units : %	2017	2018	2019	2020	2021	2022/H1	Gross Margin
Trading	54	57	59	58	60	60	Below Average
Manufacturing	46	43	41	42	40	40	Above Average

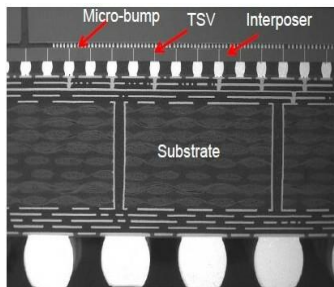
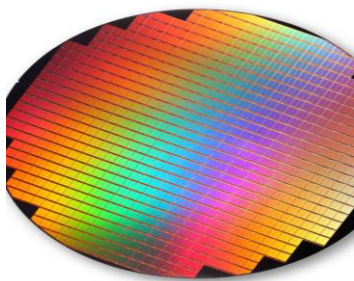


Product (Units : NT \$ M)	1H21		2H21		1H22		YoY
Trading	1,293	66%	1,540	56%	1,594	60%	23%
Manufacturing	665	34%	1,186	44%	1,043	40%	57%
Total	1,959	100%	2,725	100%	2,637	100%	35%

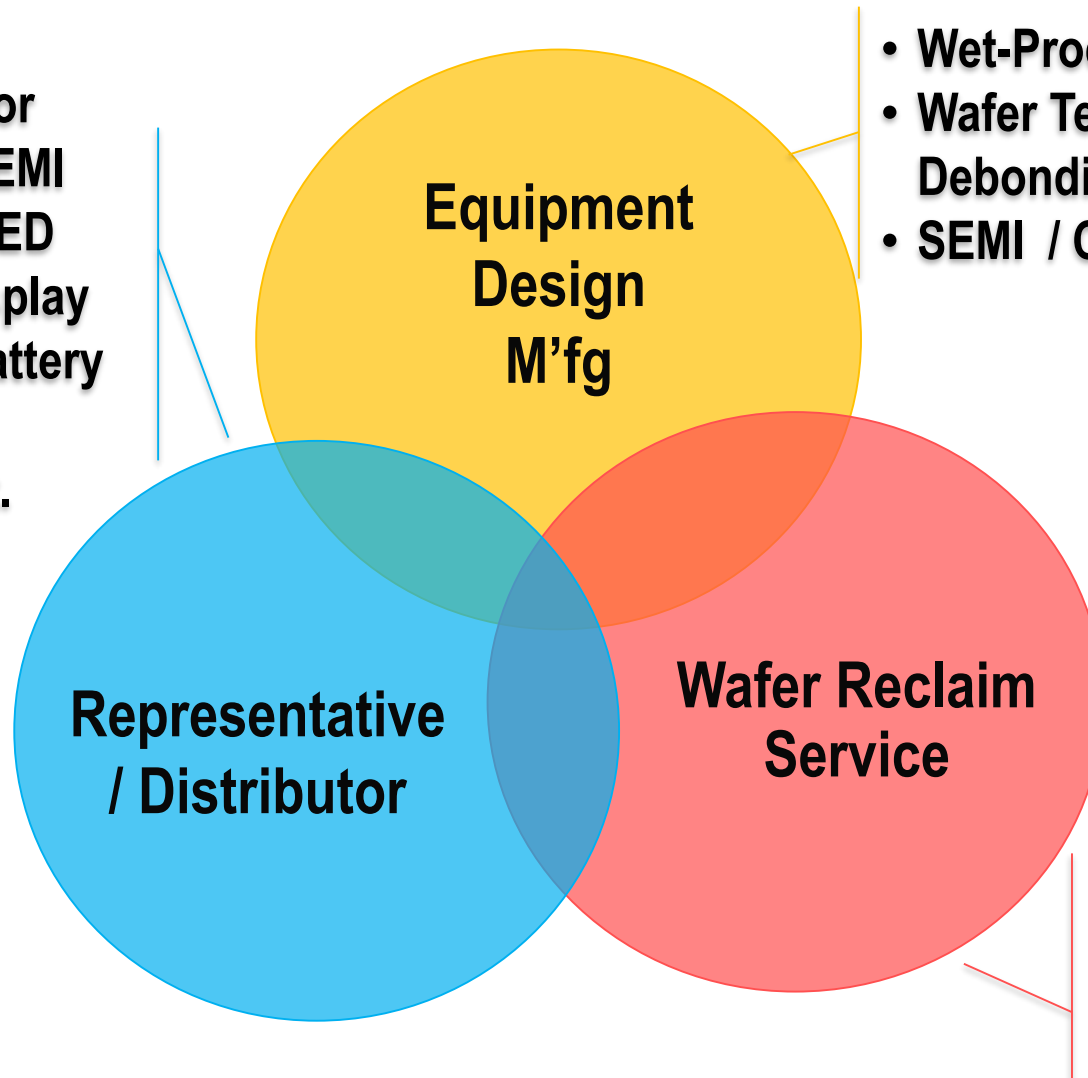
Units : NT \$ M	2017	2018	2019	2020	2021	2022/1H
R&D Expenses	228	246	246	248	280	178
Expenses as % of Revenue	6.4%	6.2%	6.2%	6.9%	6.0%	6.7%



- Industries which we serve:
 - Semiconductor (Front-End and Advanced Packaging)
 - Compound Semiconductor
 - LED / Mini LED / Micro LED
 - Flat Panel Display (TFT-LCD, AMOLED, Touch Panel)
 - Solar Cell / Battery
 - Biotech / Chemistry Analysis / Scientific Instrument,...



- Semiconductor
- Compound SEMI
- LED / Micro LED
- Flat Panel Display
- Solar Cell / Battery
- Biotech
- Scientific Inst.



- Wet-Process Tools
- Wafer Temporary Bonding Debonding System
- SEMI / Compound / LED

- 12" Si Wafer
- 6" SiC Wafer

- Sciencetech Corp.



- 12" Wafer Reclaim

- ◆ Capacity: 120K→140K
→160K/ Month
- ◆ Cu and Non-Cu Process

- SiC Post Slicing Process and Reclaim

- ◆ Capacity: 800 / Month

Advanced clean technology

- 65nm/ 45nm Particle
- Low trace metal (<1E10)



Complete particle inspection
(SP1-DLS & SP2)

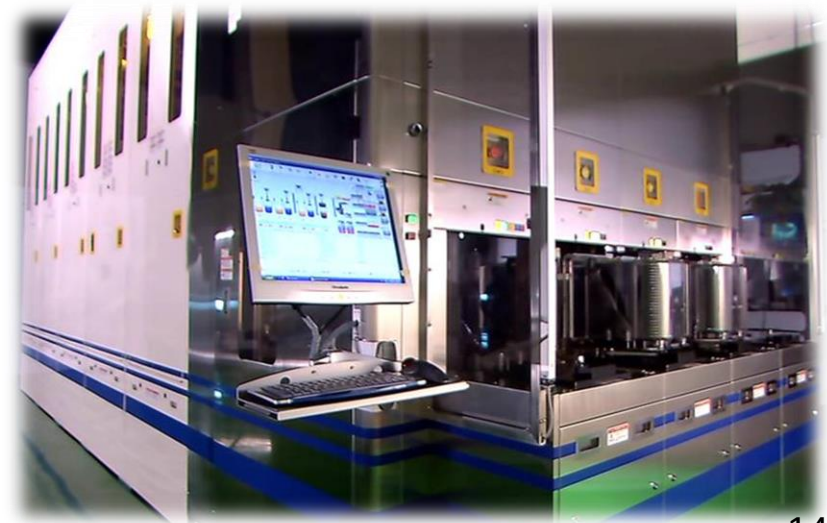


- **Sciencetech Corp.**



SCIENTECH

- **Wet-Bench / Single-Wafer Wet Process Equipment**
- **Applications:**
 - ◆ Advanced Packaging Process
 - ◆ Semiconductor Front-End Process
 - ◆ Compound Semiconductor
 - ◆ Microelectromechanical Systems (MEMS)
 - ◆ High-End LED Fully-Automatic Advanced Process



- **Sciencetech Corp.**



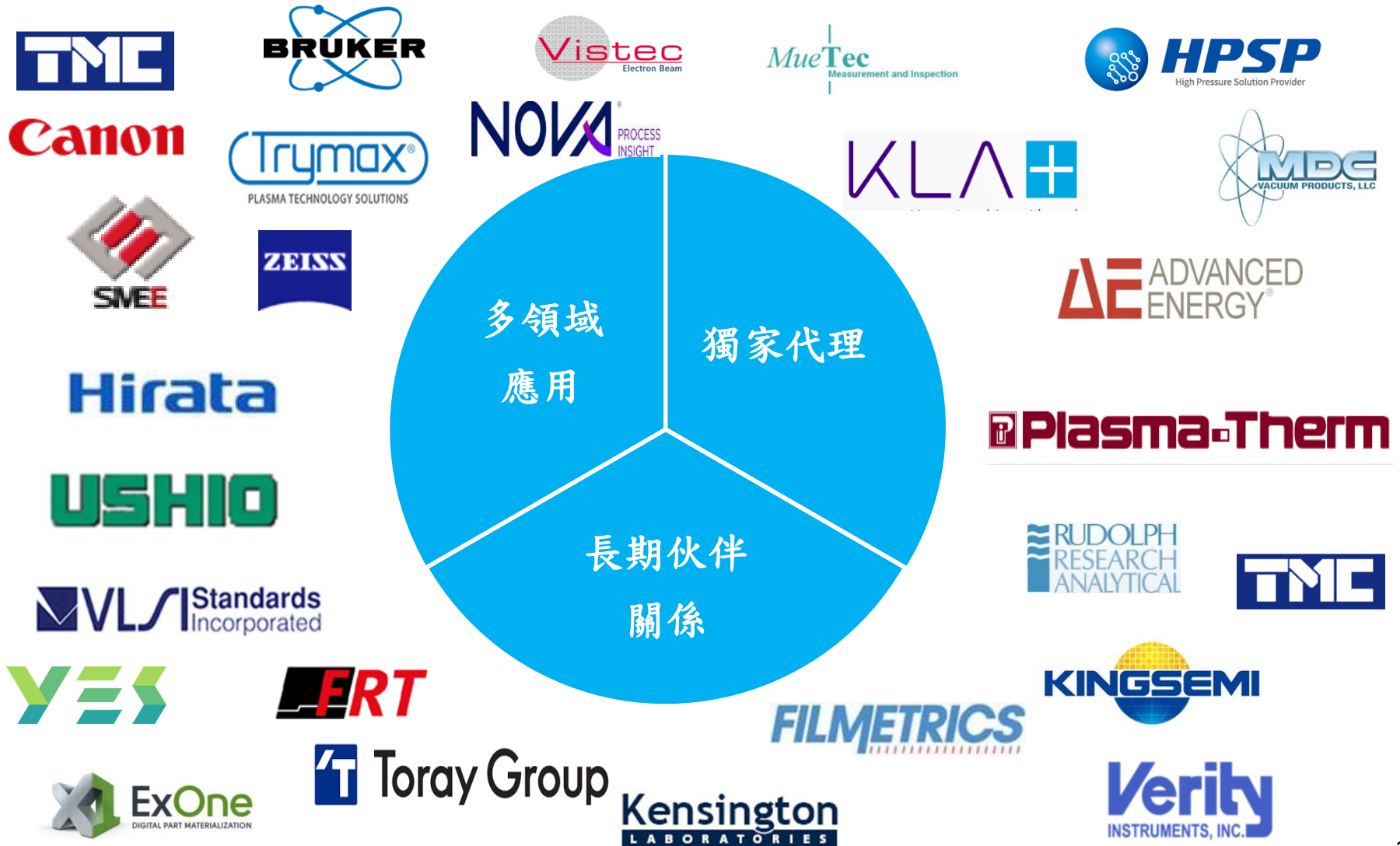
SCIENTECH

- **Temporary Bonding Debonding System (TBDB)**
- **Application: IGBT Power Device, Advanced Packaging for Semiconductor and LED**
 - ◆ Temporary Bonding System
 - ◆ Temporary Debonding System
 - ◆ Release Layer Formation System
 - ◆ Carrier (Glass) Recycling System



Products

Trading (Agent/Distributor)




Taiwan Intellectual Property Management System

台灣智慧財產管理規範（TIPS）驗證登錄證書
Certificate of Taiwan Intellectual Property Management System

貴公司所建置之智慧財產管理制度，通過台灣智慧財產管理規範（TIPS）推行體系之驗證，特此證明。相關登錄事項如下：

一、公司名稱：辛耘企業股份有限公司
二、受評部門：全公司
三、受評地址：新竹縣礁口鄉中華路 18 號
四、證書編號：TIPS-2016-驗證-008
五、有效期限：2021/12/31
六、管理標的：☒專利 ☒商標 ☒著作權 ☒營業秘密 ☐積體電路佈局
排除適用：無
七、驗證類別：☒AA 級 ☐A 級（2016 年版）

經濟部工業局
局長 呂正華

Certificate of Compliance

This is to certify that the Intellectual Property Management System of the following organization has been verified and fulfilled the requirements of TIPS.

1. Company Name : Sciencetech Corporation
2. Registered Department : All Company
3. Registered Address : No. 18, Zhonghua Rd., Hukou Township, Hsinchu County 30352, Taiwan (R.O.C.)
4. Number of Registration : TIPS-2016-cert-008
5. Date of Expiration : December 31, 2021
6. Items : ☒ Patent ☒ Trademark ☒ Copyright ☒ Trade Secret
☐ Integrated Circuit Layout
Exclusion : None
7. Certification Level : ☒ AA ☐ A (2016)

Director General
Intellectual Development Bureau, MOEA 

Q & A



Thank You!